



Accurate Kinetic Energy

No.11-3 Jianguo Rd., Tanzi Dist., 42760 Taiwan

All dimensions are millimeters.

CAD:	TCR		
Review:	EG		
Appr:	JL		
Page:	1/4	Date:	April 24,2024

Specification Title:

**HCMOS Output Clock Oscillator  
Spread Spectrum - Low EMI  
3.2 x 2.5 millimeter Surface Mount  
General Product Specification**

Part Number:	<b>S3 Low EMI Series</b>
--------------	--------------------------

**Electrical Specifications:**

Frequency Range	20.000-40.000			MHz	
Frequency Stability	±25 ~ ±100			ppm	
Aging per Year	±3			ppm Max.	
Operating Temperature Range	Standard	-20 ~ +70		°C	
	Option	-40 ~ +85			
	Option	-40 ~ +105			
	Option	-40 ~ +125			
Storage Temperature Range	-55 ~ +125				
Supply Voltage	1.8 ± 5%	2.5 ± 5%	3.3 ± 5%	VDD	
Input Current	20.000 to 40.000MHz	10	12	15	mA Max.
Output Voltage	Logic High (Voh)	90%			VDD Min.
	Logic Low (Vol)	10%			VDD Max.
Output Symmetry (Duty Cycle)	Standard	40 ~ 60			%
	Extended	45 ~ 55			
Output Type	CMOS				
Output Load	15			pF Max.	
Rise and Fall Time	20.000 to 40.000MHz	7	6	5	ns Max.
Enable-Disable Function	Tri-State				
Input Enable Voltage	70%			VDD Min.	
Input Disable Voltage	30%			VDD Max.	
Modulation Frequency	30 ~ 300			KHz	
Spread Spectrum Modulation	Center Spread	±0.12 ~ ±0.78	±0.09 ~ ±0.54	±0.07 ~ ±0.35	%
Start Up Time	10			ms Max.	

Temperature stability is Inclusive of all conditions:  
Calibration Tolerance at +25°C, frequency stability over the operating temperature range, supply voltage change, output load change, shock, vilbration, and 1st year aging at +25°C.

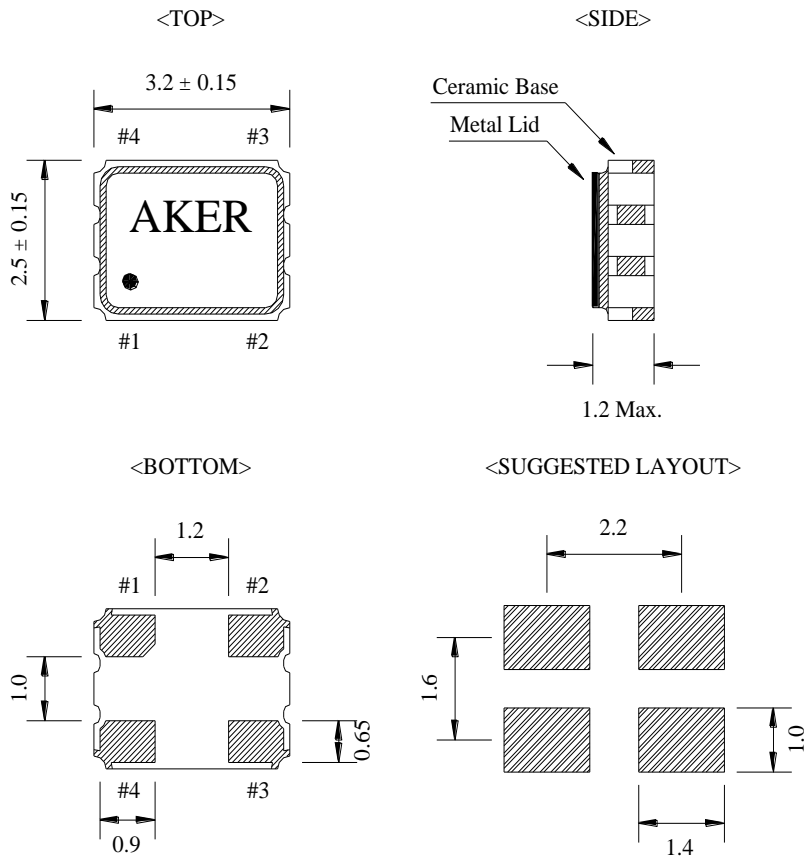
**RoHS Compliant  
Pb - Lead Free**

Ltr	Revisions	Date	Appr

## Spread Spectrum Modulation Specifications:

Supply Voltage	Center Spread	
3.3 ± 5%	LE3	±0.07 ~ ±0.35
2.5 ± 5%	LE2	±0.09 ~ ±0.54
1.8 ± 5%	LE1	±0.12 ~ ±0.78

## Mechanical Outline and Solder Pad Layout:



Pin Connection	
PIN No.	Connection
#1	Enable/Disable
#2	GND
#3	Output
#4	VDD

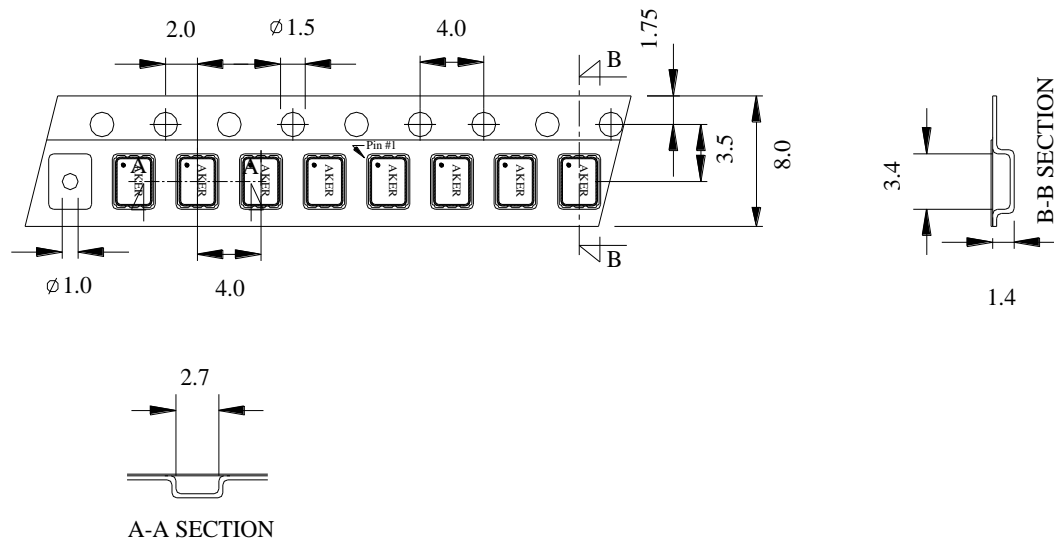
Enable/Disable Function	
PIN #1	PIN #3
HIGH or OPEN	Operating
LOW	High Impedance

**Package is Seam Sealed Ceramic-Metal.**

**Terminator Pads are Ni/Au.**

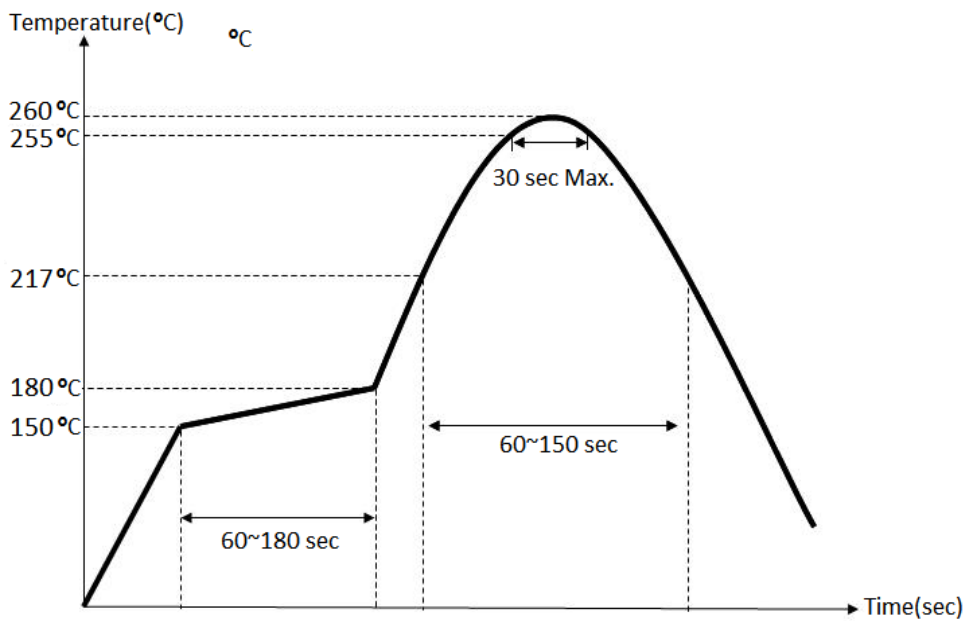
**Dimensions are millimeters.**

### Carrier Tape Dimensions:



Dimensions are millimeters.

### Solder Reflow Characteristics:



### How to build a Part Number:

Series	S	Parameter
Package	3	3.2 x 2.5 mm
Supply Voltage	33	+3.3 VDD ± 5%
	25	+2.5 VDD ± 5%
	18	+1.8 VDD ± 5%
Temperature Stability	10	±100 ppm
	05	±50 ppm
	03	±30 ppm
	025	±25 ppm
	020	±20 ppm
Duty Cycle	See Notes	40%~60%
	T	45%~55%
Frequency	20.000~40.000	MHz
Temperature Range	See Notes	-20 ~ +70 °C
	X	-40 ~ +85 °C
	X1	-40 ~ +125 °C
	X2	-40 ~ +105 °C
Spread Spectrum Modulation (Center Spread)	LE3	±0.07% ~ ±0.35%
	LE2	±0.09% ~ ±0.54%
	LE1	±0.12% ~ ±0.78%
Packaging	M	250pcs Reel
	R	1000pcs Reel
	R3	3000pcs Reel

### Part Number Example:

S33305T-24.000-X-LE3-R

S3: 3.2 x 2.5 mm SMD Package

33: +3.3±10% VDD Supply Voltage

05: ±50 ppm Temperature Stability

T: 45%~55% Tight Symmetry

24.000 MHz Nominal Frequency

X: -40 ~ + 85°C Temperature Range

LE3: ±0.07% ~ ±0.35% Center Spread (See Page 2 For Other Specifications)

R: Tape and Reel Packaging - 1000pcs Reel

### Notes:

- 1- Standard Duty Cycle and Temperature Range do not need to be included in Part Number description.
- 2- Product is shipped in Tape and Reel configuration.
- 3- Quantities less than 250pcs are shipped in tape only.
- 4- Specification subject to change without notice.